


**APPLICATION DATA SHEET**

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	SELF-CONTAINED PROCESSOR SUBSYSTEM AS COMPONENT FOR SYSTEM-ON-CHIP DESIGN	
Application Type : regular, utility		
Attorney Docket Number : FIS920030113		
Correspondence address:		
Customer Number:	23389	
Inventors Information:		
<u>Inventor 1:</u>		
<b>Applicant Authority Type:</b>	Inventor	
<b>Citizenship:</b>	US	
<b>Given Name:</b>	Christos	
<b>Middle Name:</b>	J.	
<b>Family Name:</b>	Georgiou	
<b>Residence:</b>		
<b>City of Residence:</b>	Scarsdale	
<b>State of Residence:</b>	NY	
<b>Country of Residence:</b>	US	
<b>Address-1 of Mailing Address:</b>	19 Arlington Road	
<b>Address-2 of Mailing Address:</b>		
<b>City of Mailing Address:</b>	Scarsdale	
<b>State of Mailing Address:</b>	NY	
<b>Postal Code of Mailing Address:</b>	10583	
<b>Country of Mailing Address:</b>	US	
<b>Phone:</b>		
<b>Fax:</b>		
<b>E-mail:</b>		
<u>Inventor 2:</u>		
<b>Applicant Authority Type:</b>	Inventor	
<b>Citizenship:</b>	US	
<b>Given Name:</b>	Victor	
<b>Middle Name:</b>	L.	

**Family Name:** Gregurick  
**Residence:**  
**City of Residence:** Hyde Park  
**State of Residence:** NY  
**Country of Residence:** US  
**Address-1 of Mailing Address:** 5 Hyde Park Drive  
**Address-2 of Mailing Address:**  
**City of Mailing Address:** Hyde Park  
**State of Mailing Address:** NY  
**Postal Code of Mailing Address:** 12538  
**Country of Mailing Address:** US  
**Phone:**  
**Fax:**  
**E-mail:**

**Inventor 3:**

**Applicant Authority Type:** Inventor  
**Citizenship:** AT  
**Given Name:** Valentina  
**Family Name:** Salapura  
**Residence:**  
**City of Residence:** Chappaqua  
**State of Residence:** NY  
**Country of Residence:** US  
**Address-1 of Mailing Address:** 31 Brook Lane  
**Address-2 of Mailing Address:**  
**City of Mailing Address:** Chappaqua  
**State of Mailing Address:** NY  
**Postal Code of Mailing Address:** 10514  
**Country of Mailing Address:** US  
**Phone:**  
**Fax:**  
**E-mail:**

**Publication Information:**  
**Suggested Figure for Publication - 1**  
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**Suggested Technology Center -**  
**Total Number of Drawing Sheets - 9**

**Assignee 1:**

**Organization Name:** International Business Machines Corporation  
**Address-1 of Mailing Address:** New Orchard Road

**Address-2 of Mailing Address:**

**City of Mailing Address:** Armonk

**State of Mailing Address:** NY

**Postal Code of Mailing Address:** 10504

**Country of Mailing Address:** US

**Phone:**

**Fax:**

**E-mail:**